**Resistive Product Solutions** 

### Features:

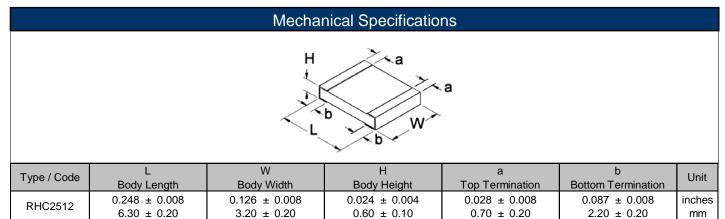
- Handles 2W of power Resistances from  $0.1\Omega$  to  $1M\Omega$
- **RoHS** compliant •
- TCR of ± 100 ppm/°C •
- 1% and 5% tolerances •
- Runs significantly cooler than standard thick film 2512 chip



Deskage Device Deting Maximum Maximum Resistance Obmin De	
Livne / Code Live Co	nge ( $\Omega$ ) and Tolerance
Type (Watts) @ 70°C Voltage <sup>(1)</sup> Voltage Coefficient	1%, 5%
RHC2512 2512 2W 200V 400V ±100 ppm/°C	0.1 - 1M

Note: (1) Lesser of  $\sqrt{P^*R}$  or maximum working voltage

Please refer to the High Power Resistor Application Note (page 5) for more information on designing and implementing high power resistor types.



Solder Pad Dimensions							
Type / Code	L Total Length	W Total Width	D Pad Depth	Unit			
RHC2512	0.315 8.00	0.138 3.50	0.118 3.00	inches mm			

Performance Characteristics					
Test	Typical				
Moisture Resistance					
Load Life					
Resistance to Soldering	±1% + 0.05Ω for <10Ω and ±1% for ≥10Ω				
Temperature Cycling	±1% + 0.0322101 < 1022 and ±1% 101 ≥1022				
Thermal Shock					
Short Time Overload					
Insulation Resistance	≥1MΩ				
Operating Temperature Range: -55°C to +155°C					

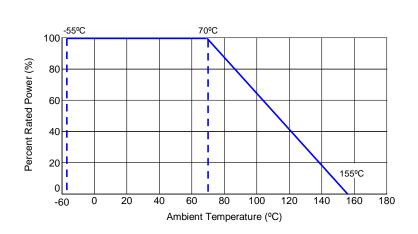
Operating Temperature Range: -55°C to +155°C

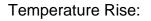
# RHC Series

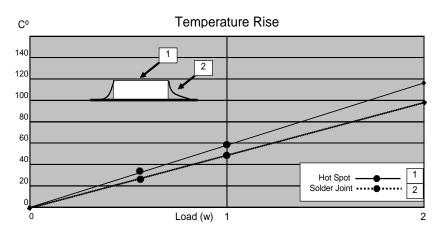
High Power Thick Film Chip Resistor

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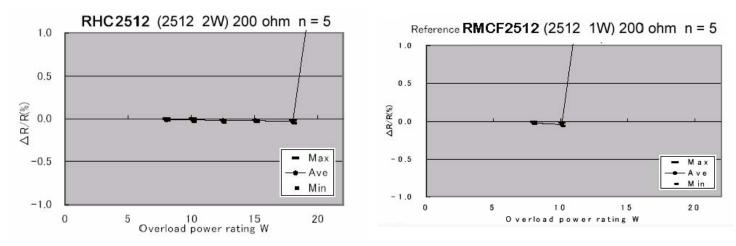








Repeated Overload:



Test condition:

Voltage (Power): 2.0, 2.25, 2.5, 2.75, 3.0, 3,25 times of rated voltage. (8W, 10.1W, 12.5W, 15.1W, 18W, 21.1W)

#### Applied time:

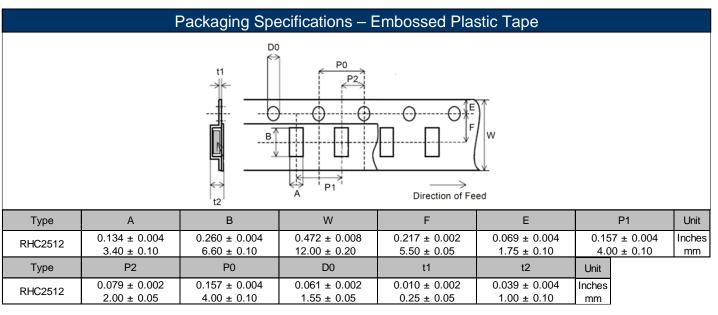
Each voltage 5 seconds.

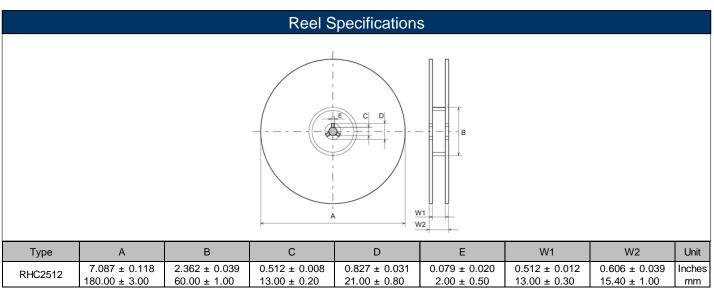
As a reference test, the RMC was tested with the same rated voltage and testing substrate.

## **RHC Series**

High Power Thick Film Chip Resistor

**Resistive Product Solutions** 





## **RoHS** Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 2). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament.

RoHS Compliance Status							
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)	
RHC	High Power Thick Film Surface Mount Chip Resistor	SMD	YES(1)	100% Matte Sn over Ni	Jul-04	04/27	
Note (1): RoHS Compliant by means of exemption 7c-I.							

## "Conflict Metals" Commitment

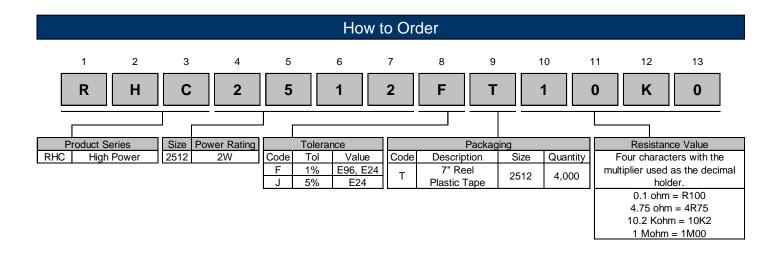
We at Stackpole electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the Easter Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

## Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

## **Environmental Policy**

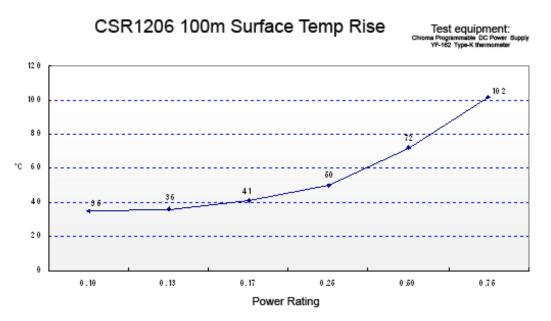
It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.



## High Power Chip Resistors and Thermal Management

Stackpole has developed several surface mount resistor series in addition to our current sense resistors, which have had higher power ratings than standard resistor chips. This has caused some uncertainty and even confusion by users as to how to reliably use these resistors at the higher power ratings in their designs.

The data sheets for the RHC, RMCP, RNCP, CSR, CSRN, CSRF, CSS, and CSSH state that the rated power assumes an ambient temperature of no more than 100 degrees C for the CSS / CSSH series and 70 degrees C for all other high power resistor series. In addition, IPC and UL best practices dictate that the combined temperature on any resistor due to power dissipated and ambient air shall be no more than 105C. At first glance this wouldn't seem too difficult, however the graph below shows typical heat rise for the CSR ½ 100 milliohm at full rated power. The heat rise for the RMCP and RNCP would be similar. The RHC with its unique materials, design, and processes would have less heat rise and therefore would be easier to implement for any given customer.



The 102 degrees C heat rise shown here would indicate there will be additional thermal reduction techniques needed to keep this part under 105C total hot spot temperature if this part is to be used at 0.75 watts of power. However, this same part at the usual power rating for this size would have a heat rise of around 72 degrees C. This additional heat rise may be dealt with using wider conductor traces, larger solder pads and land patterns under the solder mask, heavier copper in the conductors, vias through PCB, air movement, and heat sinks, among many other techniques. Because of the variety of methods customers can use to lower the effective heat rise of the circuit, resistor manufacturers simply specify power ratings with the limitations on ambient air temperature and total hot spot temperatures and leave the details of how to best accomplish this to the design engineers. Design guidelines for products in various market segments can vary widely so it would be unnecessarily constraining for a resistor manufacturer to recommend the use of any of these methods over another.

Note: The final resistance value can be affected by the board layout and assembly process, especially the size of the mounting pads and the amount of solder used. This is especially notable for resistance values  $\leq 50 \text{ m}\Omega$ . This should be taken into account when designing.